

产 品 技 术 规 格 书  
SPECIFICATION

|                               |
|-------------------------------|
| 产品型号 PART NO: KH-LF2012-N255K |
| 客户料号 CUSTOMER PART NO:        |
| 客户确认 CUSTOMER APPROVED BY:    |
| 确认日期 APPROVED DATE:           |

RoHS Compliant Parts

|                 |                                   |                 |
|-----------------|-----------------------------------|-----------------|
| 拟制 Prepared by: | 审核 Checked by :                   | 批准 Approved by: |
| 送样日期 Formed On  | 产品版本 Document Version<br>( V2.0 ) |                 |

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产品规格书版本更改记录  
Version rejigger track record

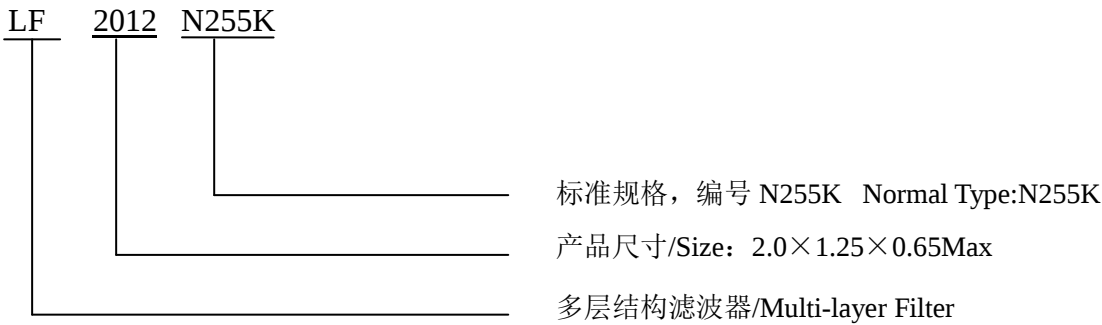
| 版本号<br>Version                                                                                                    | 更改记录 Rejigger   | 拟制<br>Prepared | 批准<br>Approve | 日期<br>Date   |
|-------------------------------------------------------------------------------------------------------------------|-----------------|----------------|---------------|--------------|
| V1.0                                                                                                              | 首次发行            | 苏彩琴            | 罗昌桅           | 2021. 12. 20 |
| V2.0                                                                                                              | 修正第 5 点电气性能输入功率 | 苏彩琴            | 罗昌桅           | 2023. 08. 09 |
|                                                                                                                   |                 |                |               |              |
|                                                                                                                   |                 |                |               |              |
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|                                                                                                                   |                 |                |               |              |
|                                                                                                                   |                 |                |               |              |
|                                                                                                                   |                 |                |               |              |
| 备注：<br>1、更改产品电性能指标时，版本号需更换（V1.0 换为 V2.0、V3.0……）；<br>2、更改产品测试方法（包括可靠性测试条件），或更改使用条件时，当前版本号加系列（V1.0 换为 V1.1、V1.2……）。 |                 |                |               |              |

1. 概述 INTRODUCTION

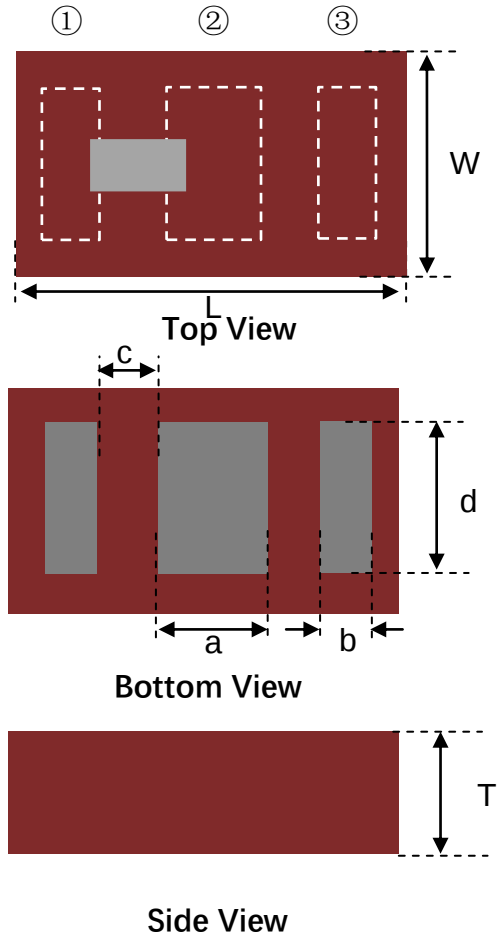
微波带通滤波器 LF 系列产品设计用于 WLAN、DSTV、Bluetooth、卫星电视、PHS 和无绳电话机中，具有低的插入损耗、高的衰减和小体积 SMD 片式设计，能减少复杂的调校工作，可以简化电路设计。

Microwave Band-Pass filter LF series are designed to be used in WLAN、DSTV、Bluetooth、LNB、PHS & cordless phones with low insertion loss and high attenuation as well as small size SMD chip design , which can simplify your complex tuning and circuit design .

2. 型号 Part Number



3. 外型尺寸 Dimensions (Unit: mm)

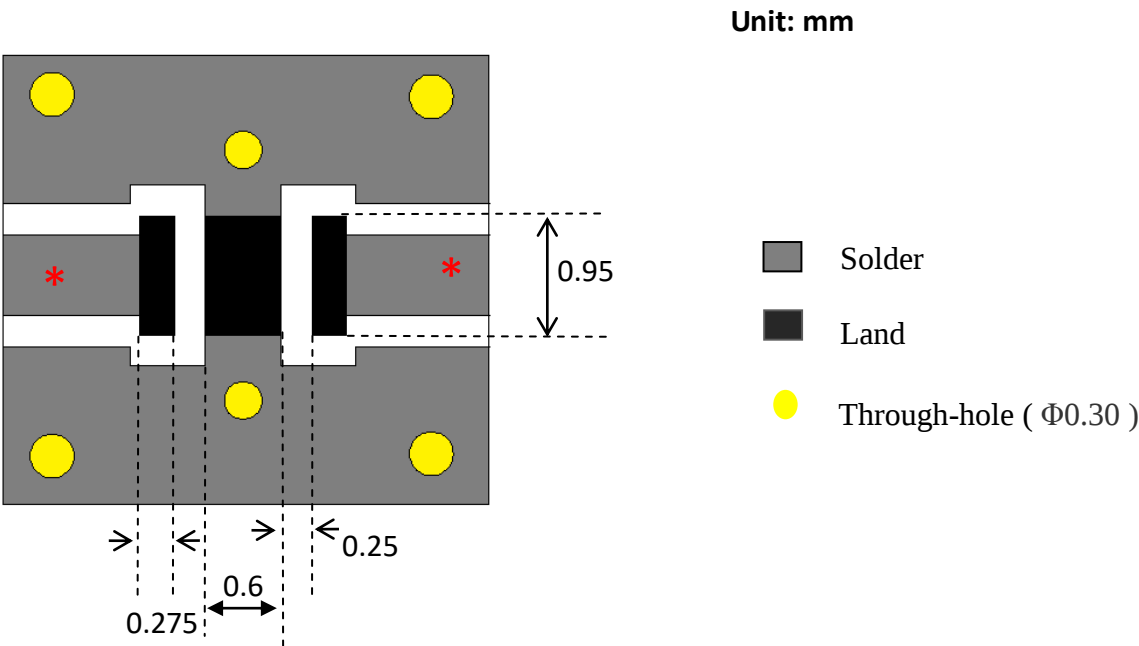


| Number | Terminal Name |
|--------|---------------|
| ①      | INPUT/OUTPUT  |
| ②      | GND           |
| ③      | OUTPUT/INPUT  |



| Symbols    | L        | W        | T       | a       | b         | c         | d        |
|------------|----------|----------|---------|---------|-----------|-----------|----------|
| Dimensions | 2.0±0.15 | 1.25±0.1 | 0.65max | 0.6±0.1 | 0.275±0.1 | 0.25±0.05 | 0.95±0.1 |

建议的 PCB 布局 ( Recommended PCB Layout )



\*Line width should be designed to match 50Ω characteristic impedance, depending on PCB material and thickness.

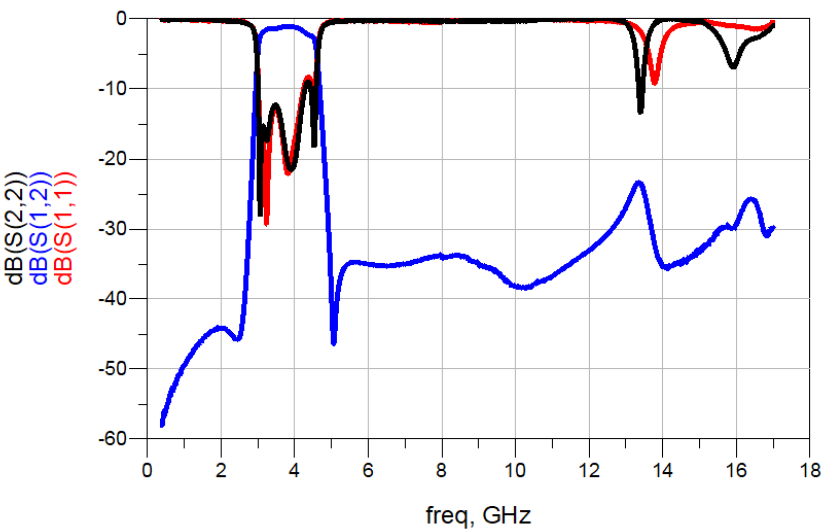
4. 结构及材料      **Structure and Material**

| No  | Part Name    名称                | Structure and Material    结构及材料  |
|-----|--------------------------------|----------------------------------|
| 4.1 | Resonator                  谐振体 | Dielectric Material    LTCC 介质材料 |
| 4.2 | In/Output Terminals    输入/输出   | Ag+Ni+Sn                  银+ 镍+锡 |
| 4.3 | Ground Base              接地面   | Ag+Ni+Sn                  银+ 镍+锡 |

5. 电气性能      **Electrical Characteristics**

| No. | Item   （项目）                   | Specifications   （特性）                                                                                                                                                                                             |
|-----|-------------------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 5.1 | Center Frequency   中心频率 fo    | 3750MHz                                                                                                                                                                                                           |
| 5.2 | Insertion Loss   插入衰耗         | ≤1.95dB(3300~4200Mhz) (at 25℃)<br>≤2.25dB(3300~4200Mhz)(-40~+85℃)<br>≤1.95dB (3300~3800Mhz) (at 25℃)<br>≤2.25dB (3300~3800Mhz) (-40~+85℃)<br>≤1.25dB (3400~3800Mhz) (at 25℃)<br>≤1.55dB (3400~3800Mhz) (-40~+85℃) |
| 5.3 | Band Width    通带宽度            | fo ± 450 MHz                                                                                                                                                                                                      |
| 5.4 | V.S.W.R (in BW)   驻波比         | ≤2.1                                                                                                                                                                                                              |
| 5.5 | Attenuation    阻带衰耗           | ≥40dB (450~2200Mhz)<br>≥40dB (2300~2483Mhz)<br>≥35dB (2496~2690Mhz)<br>≥25dB (5150~5850Mhz)<br>≥25dB (6600~8400Mhz)<br>≥20dB (9900~12600Mhz)<br>≥15dB (13200~16800Mhz)                                            |
| 5.6 | Input Power    输入功率（MAX）      | 3W                                                                                                                                                                                                                |
| 5.6 | In/Output Impedance   输入/输出阻抗 | 50 Ω                                                                                                                                                                                                              |

6. 特性曲线      **Characteristic curve**



7 可靠性试验     **Reliability Test**

|           |                             |           |
|-----------|-----------------------------|-----------|
| 基准条件：温度范围 | Temperature range           | 25±5℃     |
| 相对湿度范围    | Relative Humidity range     | 55~75%RH  |
| 工作温度      | Operating Temperature range | -40℃~+85℃ |
| 贮藏温度      | Storage Temperature range   | -40℃~+85℃ |

7.1 耐振动     **Vibration Resist**

在振动频率为 10~55Hz 振幅为 1.5mm 沿 X.Y.Z 方向各振动 2 小时后测试需符合电气性能指标。  
The device should fulfill the electrical specification after applied to the vibration of 10 to 55Hz with amplitude of 1.5mm for 2 hours each in X , Y and Z directions.

7.2 耐跌落冲击     **Drop Shock**

在 100cm 高度处按 X, Y, Z 三个面分别自由跌落在木制地板上共 3 次后，要求无机械损伤。  
The device should have no mechanical damage after dropping onto the hard wooden board from the height of 100cm for 3 times each facet of the 3 dimensions of the device.

7.3 耐焊接热     **Solder Heat Proof**

能承受经 120~150℃ 的温度预热 120 秒后，在 255℃+10℃ 的焊锡浸 5±0.5 秒，或 300℃-10℃ 的电烙铁焊接 3±0.5 秒，焊接面无损伤。

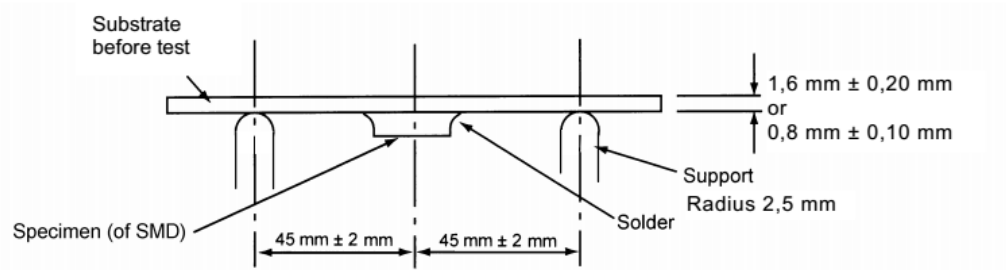
The device should be satisfied after preheating at 120℃~150℃ for 120 seconds and dipping in soldering Sn at 255℃+10℃ for 5±0.5 seconds, or electric iron 300℃-10℃ for 3±0.5 seconds, without damage.

7.4 推力试验     **Adhesive Strength of Termination**

在产品电极端子上或表面上可承受 5N(≤0603)；10N(>0603) 水平推力 10±1 秒而无明显外观损坏与电极移位。

The device have no remarkable damage or removal of the termination after horizontal force of 5N(≤0603); 10N(>0603)with 10±1 seconds.

7.5 耐弯曲试验     **Bending Resist Test**



将产品按图焊在 1.6±0.2mm 或 0.8±0.1mm 的 PCB 板中间，由箭头方向施力：1mm/S，弯曲距离：1.5mm，保持 5±1S，产品金属层无脱落。

Weld the product to the center part of the PCB with the thickness 1.6±0.2mm or 0.8±0.1mm as the illustration shows, and keep exerting force arrow-ward on it at speed of :1mm/S , and hold for 5±1S at the position of 1.5mm bending distance , so far , any peeling off of the product metal coating should not be detected .

**7.6 耐湿热特性    Moisture Proof**

在温度为  $60\pm2^{\circ}\text{C}$ ，相对湿度 90~95%的恒温湿箱中放置 96 小时，在常温中恢复 1~2 小时后测试，测试需符合电气性能指标。

The device should fulfill the electrical specification after exposed to the temperature  $60\pm2^{\circ}\text{C}$  and the relative humidity 90~95% RH for 96 hours and 1~2 hours recovery time under normal condition.

**7.7 高温特性    High Temperature Endurance**

在温度为  $85\pm5^{\circ}\text{C}$ 的恒温箱中放置  $96\pm2$  小时，在常温中恢复 1~2 小时后测试。测试需符合电气性能指标。

The device should fulfill the electrical specification after exposed to temperature  $85\pm5^{\circ}\text{C}$  for  $96\pm2$  hours and 1~2 hours recovery time under normal temperature.

**7.8 低温特性    Low Temperature Endurance**

在温度为  $-40^{\circ}\text{C}\pm5^{\circ}\text{C}$ 低温箱中放置  $96\pm2$  小时后恢复 1~2 小时，测试需符合电气性能指标。

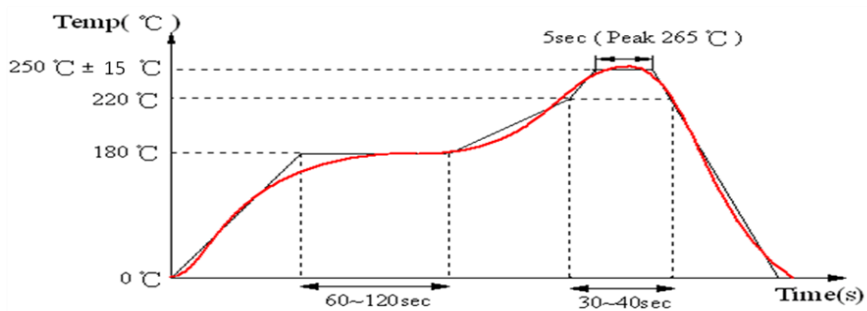
The device should fulfill the electrical specification after exposed to the temperature  $-40^{\circ}\text{C}\pm5^{\circ}\text{C}$  for  $96\pm2$  hours and to 2 hours recovery time under normal temperature.

**7.9 温度循环    Temperature Cycle Test**

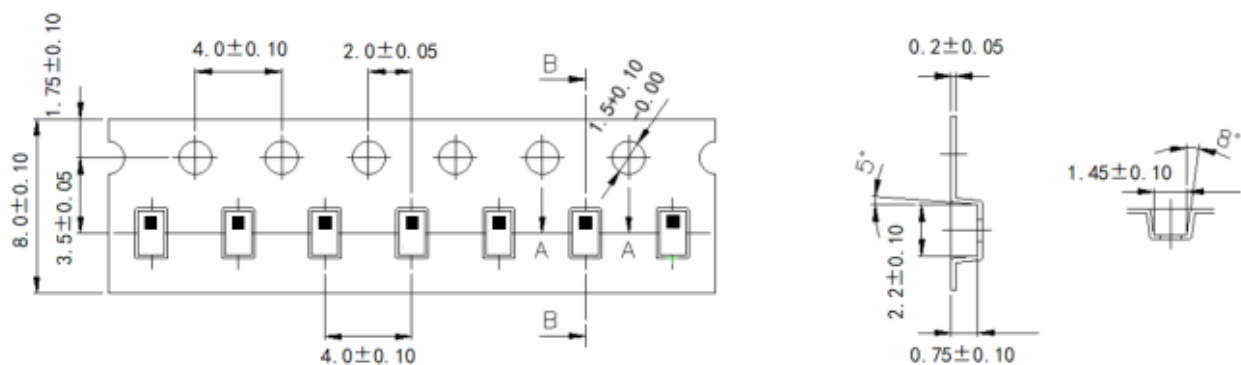
在  $-40^{\circ}\text{C}$ 温度中保持 30 分钟，再在  $+85^{\circ}\text{C}$ 温度中保持 30 分钟，共循环 5 次后在常温中恢复 1~2 小时后测试需符合电气性能指标。

The device should fulfill the electrical specification after exposed to the low temperature  $-40^{\circ}\text{C}$  and high temperature  $+85^{\circ}\text{C}$  for  $30\pm2$  min each by 5 cycles and 1 to 2 hours recovery time under normal temperature.

**8 回流焊温度    Reflow Soldering Standard Condition**



9 包装尺寸 (2012)      Packaging and Dimensions  
9.1 Plastic Tape

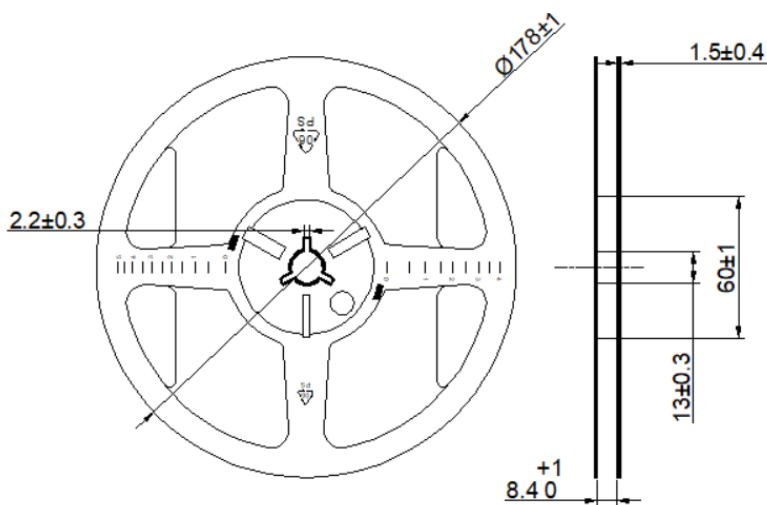


包装说明:    Remarks for Package

载带尾部空穴长度至少 200mm，载带头部空穴长度至少 200mm，头部的盖带加长至少 200mm。

Reserve a length of 200mm at least for the trailer of the carrier and 200mm at least for the leader of the carrier and further 200mm at least of cover tape at the leading part of the carrier.

9.2 Reel (4000 pcs/Reel)



9.3 储存条件    Storage Period

产品收到后一年内使用完毕。

Product should be used within twelve months of receipt.

湿敏等级 1 / 储存温度与湿度:

MSL 1 / Storage Temperature Range : -40~85 degree C, Humidity : <85%RH